CRMPTL0307A

N-Channel 30V, 6.6mΩ Typ. Power MOSFET

Description

Features

• 30V, 13A

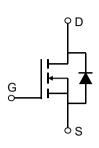
$$R_{DS(ON)}$$
 Typ = 6.6m Ω @ V_{GS} = 10 V

$$R_{DS(ON)}$$
 Typ = 10m Ω @ V_{GS} = 4.5 V

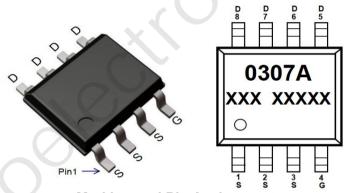
- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free
- 100% UIS TESTED!

Application

- Load Switch
- PWM Application
- Power Management







Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMPTL0307A	0307A	SOP-8	TAPING	13"	4000	40000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		30	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _A = 25°C	13	Α
I _D	Continuous Diairi Current	T _A = 100°C	7.8	Α
I _{DM}	Pulsed Drain Current (1)		52	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		33	mJ
P_{D}	Power Dissipation	T _A = 25°C	2.5	W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient ⁽³⁾		150	°C/W
T_J,T_STG	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				G	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.5	2	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽⁴⁾	$V_{GS} = 10V, I_D = 5A$	-	6.6	8.6	mΩ
		$V_{GS} = 4.5V, I_D = 3A$	-	10	13	mΩ
Dynamic	Characteristics					
C_{iss}	Input Capacitance		-	930	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X - \	129	-	pF
C_{rss}	Reverse Transfer Capacitance	1 111112		112	-	pF
Q_g	Total Gate Charge		U -	20	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_D = 10A$	-	4	-	nC
Q_gd	Gate Drain("Miller") Charge	V _{DS} 10V, I _D 10V	-	5.5	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime	.r O	-	6	-	ns
t_r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	19	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 10A$, $R_{GEN} = 3\Omega$	-	21	-	ns
t _f	Turn-Off Fall Time		-	5	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	13	Α
$I_{\rm SM}$	Maximum Pulsed Drain to Source Diode Forward Current		-	-	52	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V$, $I_S = 5A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	I _F = 10A, di/dt = 100A/us	-	8	-	ns
Qrr	Body Diode Reverse Recovery Charge	15 - 100, 41/41 - 1007/45	-	1.6	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =15V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =11.5A

^{3.} $R_{\text{\tiny BJA}}$ is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

^{4.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.



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Test Circuit

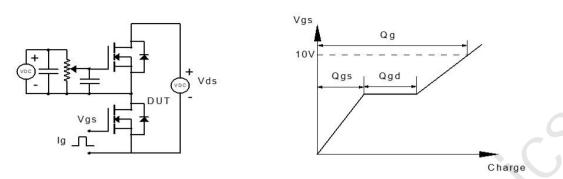


Figure 1: Gate Charge Test Circuit & Waveform

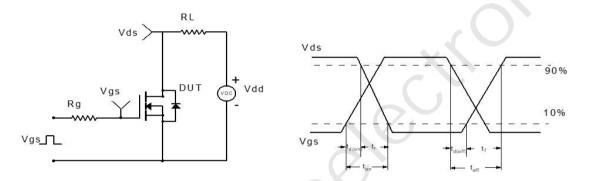


Figure 2: Resistive Switching Test Circuit & Waveform

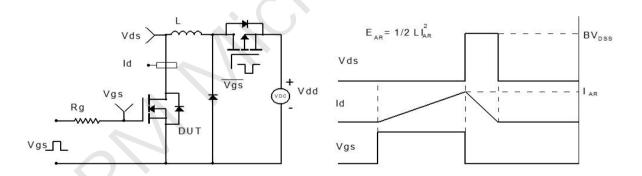


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

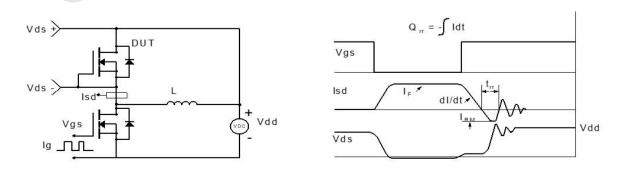
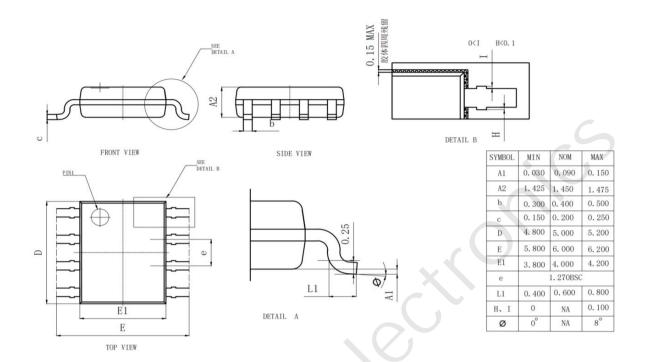


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(SOP-8)



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